

LM258, LM358, LM358A, LM2904, LM2904A, LM2904V, NCV2904



Figure 1.

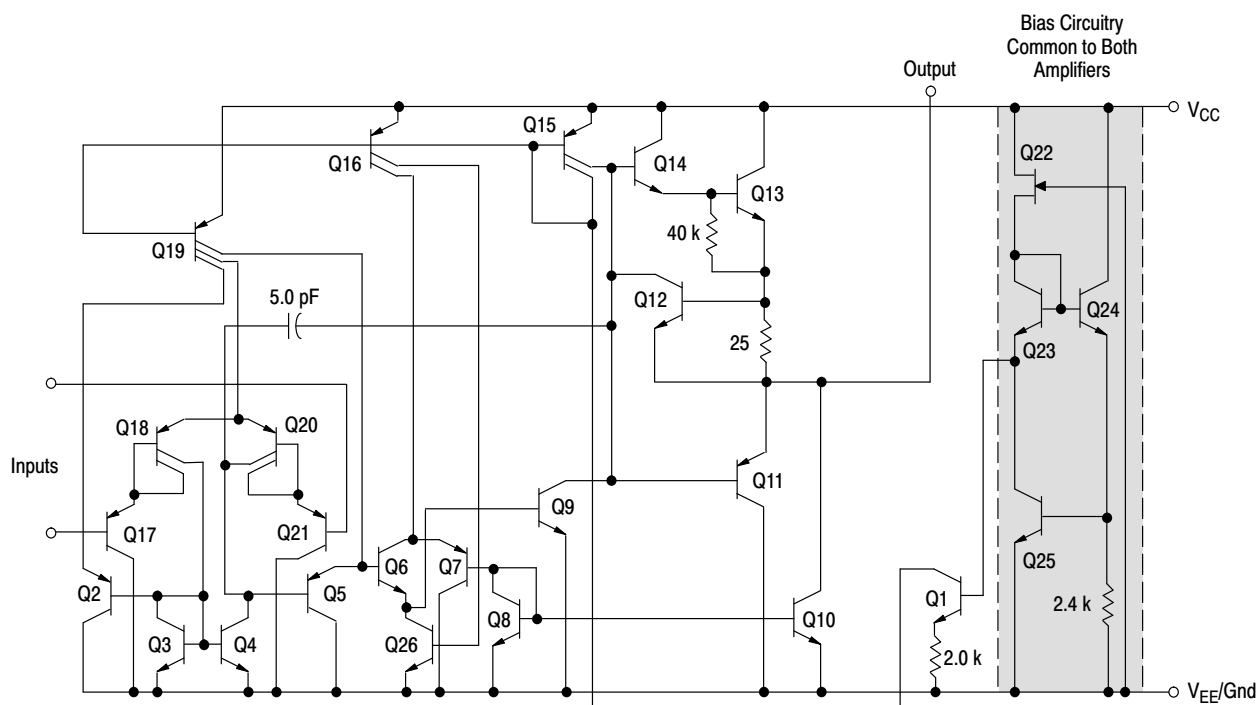


Figure 2. Representative Schematic Diagram
(One-Half of Circuit Shown)

LM258, LM358, LM358A, LM2904, LM2904A, LM2904V, NCV2904

MAXIMUM RATINGS ($T_A = +25^\circ\text{C}$, unless otherwise noted.)

Rating	Symbol	Value	Unit
Power Supply Voltages Single Supply Split Supplies	V_{CC} V_{CC}, V_{EE}	32 ± 16	Vdc
Input Differential Voltage Range (Note 1)	V_{IDR}	± 32	Vdc
Input Common Mode Voltage Range (Note 2)	V_{ICR}	-0.3 to 32	Vdc
Output Short Circuit Duration	t_{SC}	Continuous	
Junction Temperature	T_J	150	$^\circ\text{C}$
Thermal Resistance, Junction-to-Air (Note 3)	$R_{\theta JA}$	238 212 161	$^\circ\text{C/W}$
Storage Temperature Range	T_{stg}	-65 to +150	$^\circ\text{C}$
ESD Protection at any Pin Human Body Model Machine Model	V_{esd}	2000 200	V
Operating Ambient Temperature Range	T_A	-25 to +85 0 to +70 -40 to +105 -40 to +125	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Split Power Supplies.
2. For supply voltages less than 32 V the absolute maximum input voltage is equal to the supply voltage.
3. All $R_{\theta JA}$ measurements made on evaluation board with 1 oz. copper traces of minimum pad size. All device outputs were active.
4. *NCV2904 is qualified for automotive use.*

LM258, LM358, LM358A, LM2904, LM2904A, LM2904V, NCV2904

ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0\text{ V}$, $V_{EE} = \text{GND}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

Characteristic	Symbol	LM258			LM358			LM358A			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Input Offset Voltage $V_{CC} = 5.0\text{ V}$ to 30 V , $V_{IC} = 0\text{ V}$ to $V_{CC} - 1.7\text{ V}$, $V_O \approx 1.4\text{ V}$, $R_S = 0\ \Omega$ $T_A = 25^\circ\text{C}$ $T_A = T_{\text{high}}$ (Note 5) $T_A = T_{\text{low}}$ (Note 5)	V_{IO}	–	2.0	5.0	–	2.0	7.0	–	2.0	3.0	mV
		–	–	7.0	–	–	9.0	–	–	5.0	
		–	–	7.0	–	–	9.0	–	–	5.0	
Average Temperature Coefficient of Input Offset Voltage $T_A = T_{\text{high}}$ to T_{low} (Note 5)	$\Delta V_{IO}/\Delta T$	–	7.0	–	–	7.0	–	–	7.0	–	$\mu\text{V}/^\circ\text{C}$
Input Offset Current $T_A = T_{\text{high}}$ to T_{low} (Note 5)	I_{IO}	–	3.0	30	–	5.0	50	–	5.0	30	nA
		–	–	100	–	–	150	–	–	75	
Input Bias Current $T_A = T_{\text{high}}$ to T_{low} (Note 5)	I_{IB}	–	–45	–150	–	–45	–250	–	–45	–100	
		–	–50	–300	–	–50	–500	–	–50	–200	
Average Temperature Coefficient of Input Offset Current $T_A = T_{\text{high}}$ to T_{low} (Note 5)	$\Delta I_{IO}/\Delta T$	–	10	–	–	10	–	–	10	–	$\text{pA}/^\circ\text{C}$
Input Common Mode Voltage Range (Note 6), $V_{CC} = 30\text{ V}$ $V_{CC} = 30\text{ V}$, $T_A = T_{\text{high}}$ to T_{low}	V_{ICR}	0	–	28.3	0	–	28.3	0	–	28.5	V
		0	–	28	0	–	28	0	–	28	
Differential Input Voltage Range	V_{IDR}	–	–	V_{CC}	–	–	V_{CC}	–	–	V_{CC}	V
Large Signal Open Loop Voltage Gain $R_L = 2.0\text{ k}\Omega$, $V_{CC} = 15\text{ V}$, For Large V_O Swing, $T_A = T_{\text{high}}$ to T_{low} (Note 5)	A_{VOL}	50	100	–	25	100	–	25	100	–	V/mV
		25	–	–	15	–	–	15	–	–	
Channel Separation $1.0\text{ kHz} \leq f \leq 20\text{ kHz}$, Input Referenced	CS	–	–120	–	–	–120	–	–	–120	–	dB
Common Mode Rejection $R_S \leq 10\text{ k}\Omega$	CMR	70	85	–	65	70	–	65	70	–	dB
Power Supply Rejection	PSR	65	100	–	65	100	–	65	100	–	dB
Output Voltage–High Limit $T_A = T_{\text{high}}$ to T_{low} (Note 5) $V_{CC} = 5.0\text{ V}$, $R_L = 2.0\text{ k}\Omega$, $T_A = 25^\circ\text{C}$ $V_{CC} = 30\text{ V}$, $R_L = 2.0\text{ k}\Omega$ $V_{CC} = 30\text{ V}$, $R_L = 10\text{ k}\Omega$	V_{OH}	3.3	3.5	–	3.3	3.5	–	3.3	3.5	–	V
		26	–	–	26	–	–	26	–	–	
		27	28	–	27	28	–	27	28	–	
Output Voltage–Low Limit $V_{CC} = 5.0\text{ V}$, $R_L = 10\text{ k}\Omega$, $T_A = T_{\text{high}}$ to T_{low} (Note 5)	V_{OL}	–	5.0	20	–	5.0	20	–	5.0	20	mV
Output Source Current $V_{ID} = +1.0\text{ V}$, $V_{CC} = 15\text{ V}$ $T_A = T_{\text{high}}$ to T_{low} (LM358A Only)	I_{O+}	20	40	–	20	40	–	20	40	–	mA
								10	–	–	
Output Sink Current $V_{ID} = -1.0\text{ V}$, $V_{CC} = 15\text{ V}$ $T_A = T_{\text{high}}$ to T_{low} (LM358A Only) $V_{ID} = -1.0\text{ V}$, $V_O = 200\text{ mV}$	I_{O-}	10	20	–	10	20	–	10	20	–	mA
								5.0	–	–	mA
		12	50	–	12	50	–	12	50	–	μA
Output Short Circuit to Ground (Note 7)	I_{SC}	–	40	60	–	40	60	–	40	60	mA
Power Supply Current (Total Device) $T_A = T_{\text{high}}$ to T_{low} (Note 5) $V_{CC} = 30\text{ V}$, $V_O = 0\text{ V}$, $R_L = \infty$ $V_{CC} = 5\text{ V}$, $V_O = 0\text{ V}$, $R_L = \infty$	I_{CC}	–	1.5	3.0	–	1.5	3.0	–	1.5	2.0	mA
		–	0.7	1.2	–	0.7	1.2	–	0.7	1.2	

5. LM258: $T_{\text{low}} = -25^\circ\text{C}$, $T_{\text{high}} = +85^\circ\text{C}$

LM2904/LM2904A: $T_{\text{low}} = -40^\circ\text{C}$, $T_{\text{high}} = +105^\circ\text{C}$

NCV2904 is qualified for automotive use.

LM358, LM358A: $T_{\text{low}} = 0^\circ\text{C}$, $T_{\text{high}} = +70^\circ\text{C}$

LM2904V & NCV2904: $T_{\text{low}} = -40^\circ\text{C}$, $T_{\text{high}} = +125^\circ\text{C}$

6. The input common mode voltage or either input signal voltage should not be allowed to go negative by more than 0.3 V . The upper end of the common mode voltage range is $V_{CC} - 1.7\text{ V}$.

7. Short circuits from the output to V_{CC} can cause excessive heating and eventual destruction. Destructive dissipation can result from simultaneous shorts on all amplifiers.

LM258, LM358, LM358A, LM2904, LM2904A, LM2904V, NCV2904

ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0\text{ V}$, $V_{EE} = \text{Gnd}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

Characteristic	Symbol	LM2904			LM2904A			LM2904V, NCV2904			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Input Offset Voltage $V_{CC} = 5.0\text{ V}$ to 30 V , $V_{IC} = 0\text{ V}$ to $V_{CC} - 1.7\text{ V}$, $V_O \approx 1.4\text{ V}$, $R_S = 0\ \Omega$ $T_A = 25^\circ\text{C}$ $T_A = T_{\text{high}}$ (Note 8) $T_A = T_{\text{low}}$ (Note 8)	V_{IO}	–	2.0	7.0	–	2.0	7.0	–	–	7.0	mV
Average Temperature Coefficient of Input Offset Voltage $T_A = T_{\text{high}}$ to T_{low} (Note 8)	$\Delta V_{IO}/\Delta T$	–	7.0	–	–	7.0	–	–	7.0	–	$\mu\text{V}/^\circ\text{C}$
Input Offset Current $T_A = T_{\text{high}}$ to T_{low} (Note 8)	I_{IO}	–	5.0	50	–	5.0	50	–	5.0	50	nA
Input Bias Current $T_A = T_{\text{high}}$ to T_{low} (Note 8)	I_{IB}	–	–45	–250	–	–45	–100	–	–45	–250	nA
Average Temperature Coefficient of Input Offset Current $T_A = T_{\text{high}}$ to T_{low} (Note 8)	$\Delta I_{IO}/\Delta T$	–	10	–	–	10	–	–	10	–	$\text{pA}/^\circ\text{C}$
Input Common Mode Voltage Range (Note 9), $V_{CC} = 30\text{ V}$ $V_{CC} = 30\text{ V}$, $T_A = T_{\text{high}}$ to T_{low}	V_{ICR}	0	–	28.3	0	–	28.3	0	–	28.3	V
Differential Input Voltage Range	V_{IDR}	–	–	V_{CC}	–	–	V_{CC}	–	–	V_{CC}	V
Large Signal Open Loop Voltage Gain $R_L = 2.0\text{ k}\Omega$, $V_{CC} = 15\text{ V}$, For Large V_O Swing, $T_A = T_{\text{high}}$ to T_{low} (Note 8)	A_{VOL}	25 15	100 –	– –	25 15	100 –	– –	25 15	100 –	– –	V/mV
Channel Separation $1.0\text{ kHz} \leq f \leq 20\text{ kHz}$, Input Referenced	CS	–	–120	–	–	–120	–	–	–120	–	dB
Common Mode Rejection $R_S \leq 10\text{ k}\Omega$	CMR	50	70	–	50	70	–	50	70	–	dB
Power Supply Rejection	PSR	50	100	–	50	100	–	50	100	–	dB
Output Voltage–High Limit $T_A = T_{\text{high}}$ to T_{low} (Note 8) $V_{CC} = 5.0\text{ V}$, $R_L = 2.0\text{ k}\Omega$, $T_A = 25^\circ\text{C}$ $V_{CC} = 30\text{ V}$, $R_L = 2.0\text{ k}\Omega$ $V_{CC} = 30\text{ V}$, $R_L = 10\text{ k}\Omega$	V_{OH}	3.3 26 27	3.5 – 28	– – –	3.3 26 27	3.5 – 28	– – –	3.3 26 27	3.5 – 28	– – –	V
Output Voltage–Low Limit $V_{CC} = 5.0\text{ V}$, $R_L = 10\text{ k}\Omega$, $T_A = T_{\text{high}}$ to T_{low} (Note 8)	V_{OL}	–	5.0	20	–	5.0	20	–	5.0	20	mV
Output Source Current $V_{ID} = +1.0\text{ V}$, $V_{CC} = 15\text{ V}$	I_{O+}	20	40	–	20	40	–	20	40	–	mA
Output Sink Current $V_{ID} = -1.0\text{ V}$, $V_{CC} = 15\text{ V}$ $V_{ID} = -1.0\text{ V}$, $V_O = 200\text{ mV}$	I_{O-}	10 –	20 –	– –	10 –	20 –	– –	10 –	20 –	– –	mA μA
Output Short Circuit to Ground (Note 10)	I_{SC}	–	40	60	–	40	60	–	40	60	mA
Power Supply Current (Total Device) $T_A = T_{\text{high}}$ to T_{low} (Note 8) $V_{CC} = 30\text{ V}$, $V_O = 0\text{ V}$, $R_L = \infty$ $V_{CC} = 5\text{ V}$, $V_O = 0\text{ V}$, $R_L = \infty$	I_{CC}	– –	1.5 0.7	3.0 1.2	– –	1.5 0.7	3.0 1.2	– –	1.5 0.7	3.0 1.2	mA

8. LM258: $T_{\text{low}} = -25^\circ\text{C}$, $T_{\text{high}} = +85^\circ\text{C}$
LM2904/LM2904A: $T_{\text{low}} = -40^\circ\text{C}$, $T_{\text{high}} = +105^\circ\text{C}$
LM358, LM358A: $T_{\text{low}} = 0^\circ\text{C}$, $T_{\text{high}} = +70^\circ\text{C}$
LM2904V & NCV2904: $T_{\text{low}} = -40^\circ\text{C}$, $T_{\text{high}} = +125^\circ\text{C}$
NCV2904 is qualified for automotive use.
9. The input common mode voltage or either input signal voltage should not be allowed to go negative by more than 0.3 V. The upper end of the common mode voltage range is $V_{CC} - 1.7\text{ V}$.
10. Short circuits from the output to V_{CC} can cause excessive heating and eventual destruction. Destructive dissipation can result from simultaneous shorts on all amplifiers.

CIRCUIT DESCRIPTION

The LM358 series is made using two internally compensated, two-stage operational amplifiers. The first stage of each consists of differential input devices Q20 and Q18 with input buffer transistors Q21 and Q17 and the differential to single ended converter Q3 and Q4. The first stage performs not only the first stage gain function but also performs the level shifting and transconductance reduction functions. By reducing the transconductance, a smaller compensation capacitor (only 5.0 pF) can be employed, thus saving chip area. The transconductance reduction is accomplished by splitting the collectors of Q20 and Q18. Another feature of this input stage is that the input common mode range can include the negative supply or ground, in single supply operation, without saturating either the input devices or the differential to single-ended converter. The second stage consists of a standard current source load amplifier stage.

Each amplifier is biased from an internal-voltage regulator which has a low temperature coefficient thus giving each amplifier good temperature characteristics as well as excellent power supply rejection.

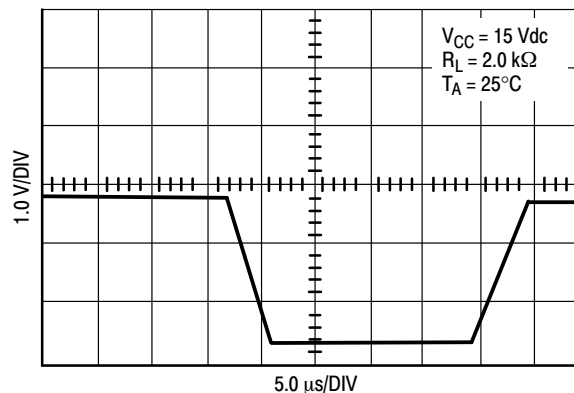


Figure 3. Large Signal Voltage Follower Response

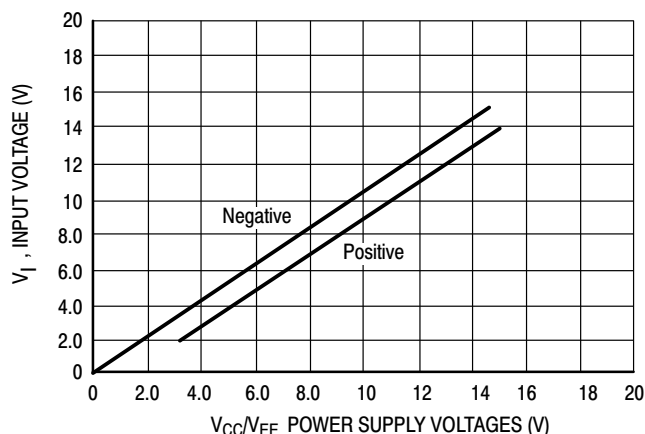


Figure 4. Input Voltage Range

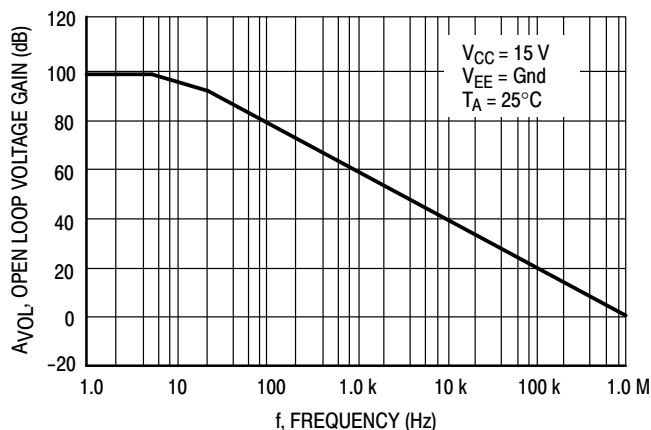


Figure 5. Large-Signal Open Loop Voltage Gain

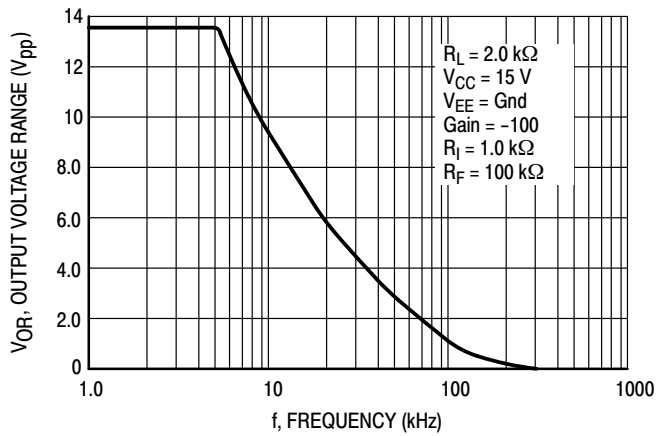


Figure 6. Large-Signal Frequency Response

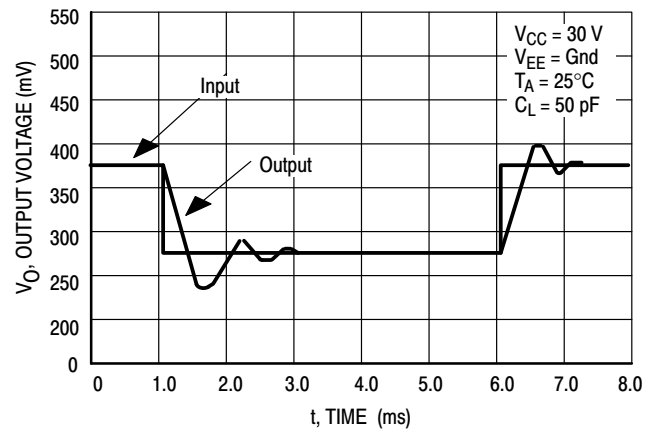


Figure 7. Small Signal Voltage Follower Pulse Response (Noninverting)

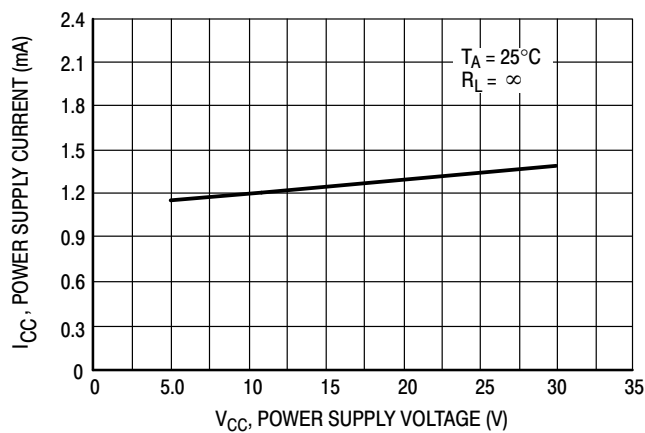


Figure 8. Power Supply Current versus Power Supply Voltage

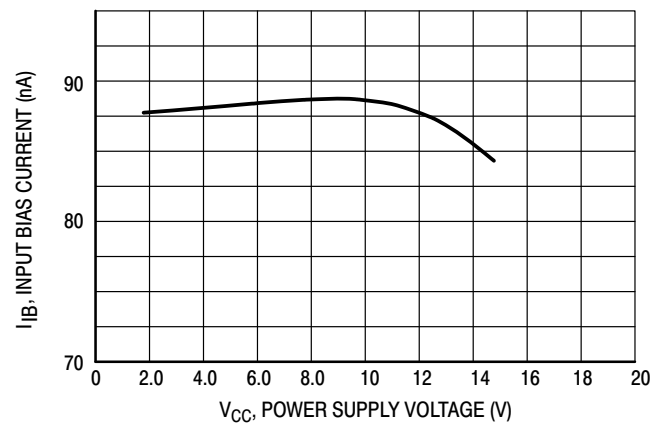


Figure 9. Input Bias Current versus Supply Voltage

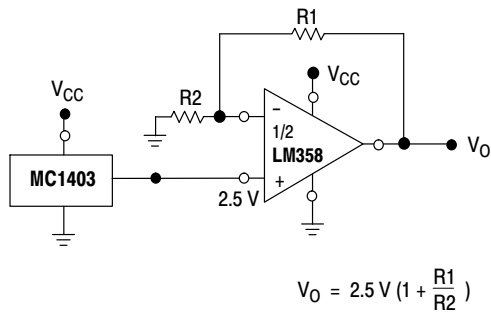


Figure 10. Voltage Reference

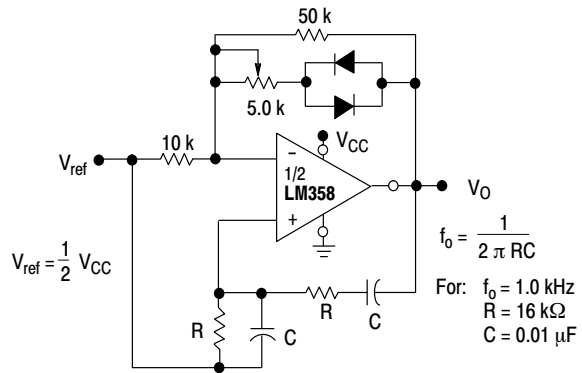


Figure 11. Wien Bridge Oscillator

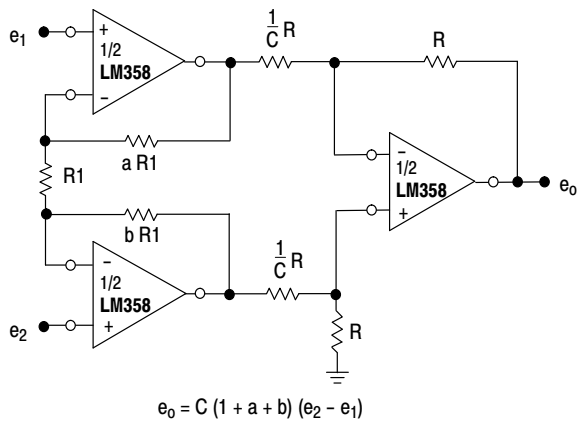


Figure 12. High Impedance Differential Amplifier

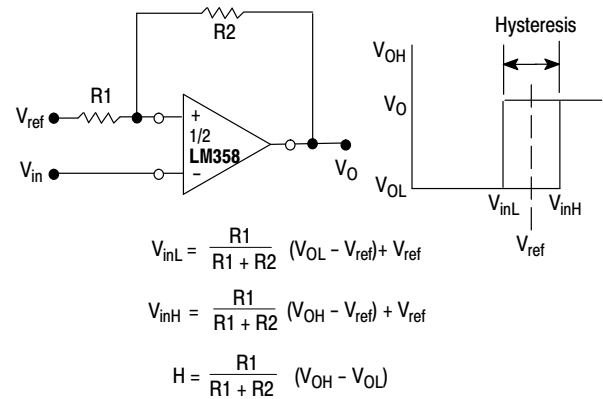


Figure 13. Comparator with Hysteresis

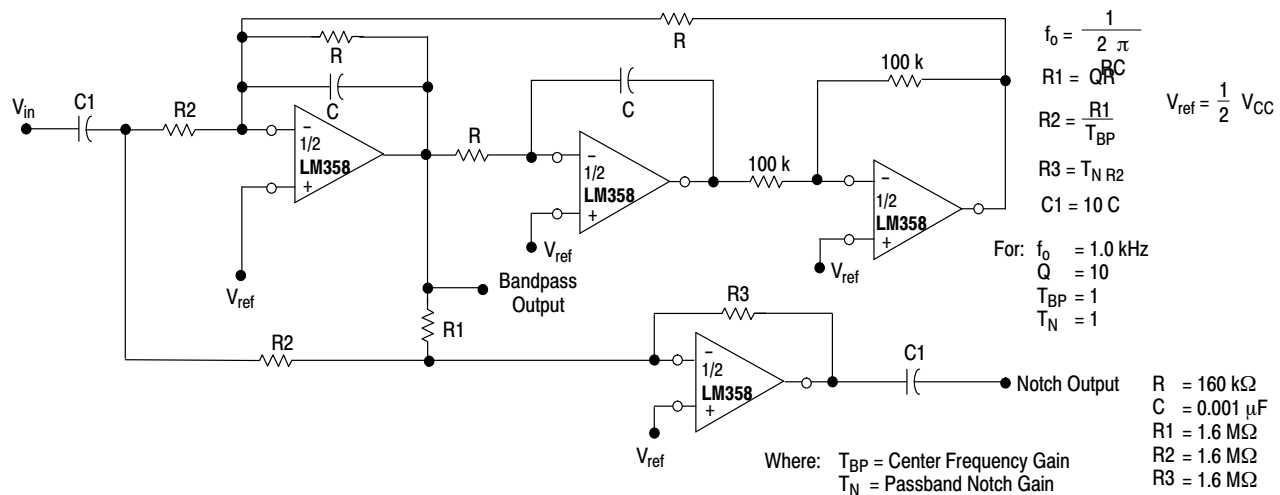


Figure 14. Bi-Quad Filter

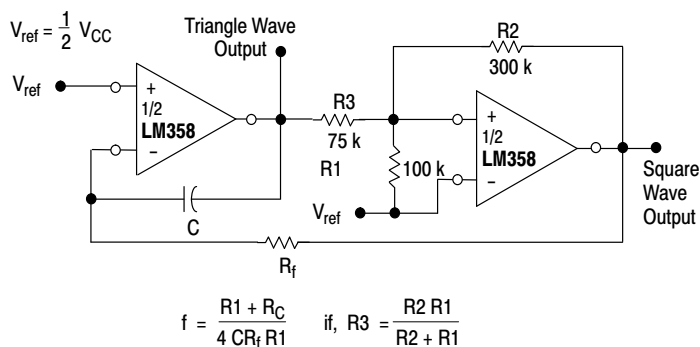
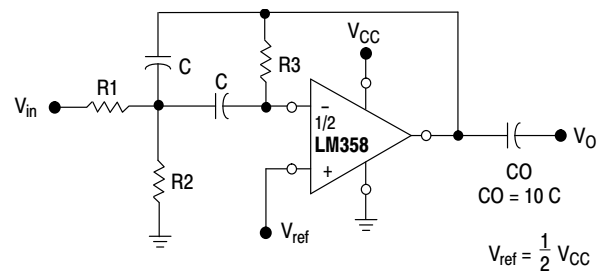


Figure 15. Function Generator



Given: f_0 = center frequency
 $A(f_0)$ = gain at center frequency

Choose value f_0, C

$$\text{Then: } R3 = \frac{Q}{\pi f_0 C}$$

$$R1 = \frac{R3}{2 A(f_0)}$$

$$R2 = \frac{R1 R3}{4 Q^2 R1 - R3}$$

For less than 10% error from operational amplifier. $\frac{Q_0 f_0}{BW} < 0.1$

Where f_0 and BW are expressed in Hz.

If source impedance varies, filter may be preceded with voltage follower buffer to stabilize filter parameters.

Figure 16. Multiple Feedback Bandpass Filter

LM258, LM358, LM358A, LM2904, LM2904A, LM2904V, NCV2904

ORDERING INFORMATION

Device	Operating Temperature Range	Package	Shipping [†]
LM358ADR2G	0°C to +70°C	SOIC-8 (Pb-Free)	2500 Tape & Reel
LM358D		SOIC-8	98 Units/Rail
LM358DG		SOIC-8 (Pb-Free)	98 Units/Rail
LM358DR2		SOIC-8	2500 Tape & Reel
LM358DR2G		SOIC-8 (Pb-Free)	2500 Tape & Reel
LM358DMR2		Micro8	4000 Tape & Reel
LM358DMR2G		Micro8 (Pb-Free)	4000 Tape & Reel
LM358N		PDIP-8	50 Units/Rail
LM358NG		PDIP-8 (Pb-Free)	50 Units/Rail
LM258D	-25°C to +85°C	SOIC-8	98 Units/Rail
LM258DG		SOIC-8 (Pb-Free)	98 Units/Rail
LM258DR2		SOIC-8	2500 Tape & Reel
LM258DR2G		SOIC-8 (Pb-Free)	2500 Tape & Reel
LM258DMR2		Micro8	4000 Tape & Reel
LM258DMR2G		Micro8 (Pb-Free)	4000 Tape & Reel
LM258N		PDIP-8	50 Units/Rail
LM258NG		PDIP-8 (Pb-Free)	50 Units/Rail
LM2904D	-40°C to +105°C	SOIC-8	98 Units/Rail
LM2904DG		SOIC-8 (Pb-Free)	98 Units/Rail
LM2904DR2		SOIC-8	2500 Tape & Reel
LM2904DR2G		SOIC-8 (Pb-Free)	2500 Tape & Reel
LM2904DMR2		Micro8	2500 Tape & Reel
LM2904DMR2G		Micro8 (Pb-Free)	2500 Tape & Reel
LM2904N		PDIP-8	50 Units/Rail
LM2904NG		PDIP-8 (Pb-Free)	50 Units/Rail
LM2904ADMG		Micro8 (Pb-Free)	4000 Tape & Reel
LM2904ADMR2		Micro8	4000 Tape & Reel
LM2904ADMR2G		Micro8 (Pb-Free)	4000 Tape & Reel
LM2904AN		PDIP-8	50 Units/Rail
LM2904ANG		PDIP-8 (Pb-Free)	50 Units/Rail

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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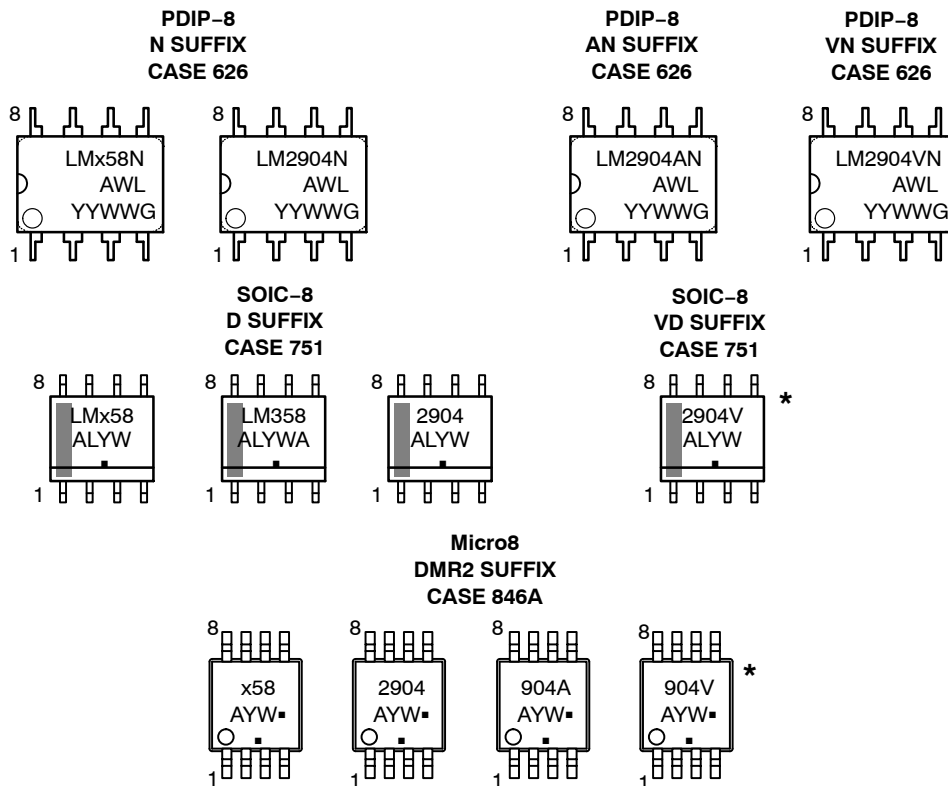
ORDERING INFORMATION

Device	Operating Temperature Range	Package	Shipping [†]
LM2904VD	-40°C to +125°C	SOIC-8	98 Units/Rail
LM2904VDG		SOIC-8 (Pb-Free)	98 Units/Rail
LM2904VDR2		SOIC-8	2500 Tape & Reel
LM2904VDR2G		SOIC-8 (Pb-Free)	2500 Tape & Reel
LM2904VDMR2		Micro8	4000 Tape & Reel
LM2904VDMR2G		Micro8 (Pb-Free)	4000 Tape & Reel
LM2904VN		PDIP-8	50 Units/Rail
LM2904VNG		PDIP-8 (Pb-Free)	50 Units/Rail
NCV2904DR2*		SOIC-8	2500 Tape & Reel
NCV2904DR2G*		SOIC-8 (Pb-Free)	2500 Tape & Reel
NCV2904DMR2*		Micro8	4000 Tape & Reel
NCV2904DMR2G*		Micro8 (Pb-Free)	4000 Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NCV2904 is qualified for automotive use.

MARKING DIAGRAMS

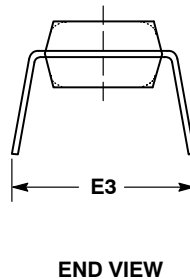
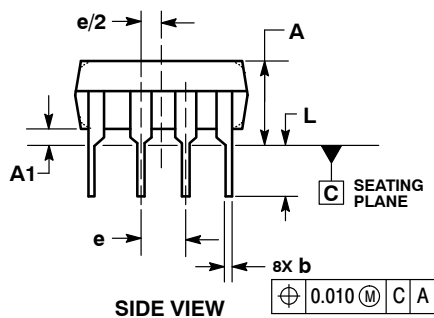
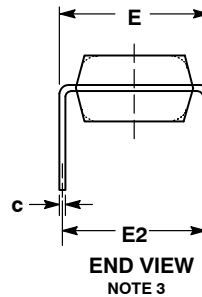
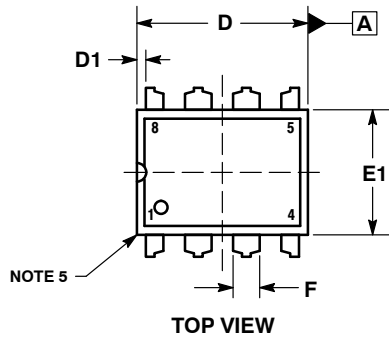


- x = 2 or 3
- A = Assembly Location
- WL, L = Wafer Lot
- YY, Y = Year
- WW, W = Work Week
- G = Pb-Free Package
- = Pb-Free Package – (Note: Microdot may be in either location)

*This diagram also applies to NCV2904

PACKAGE DIMENSIONS

PDIP-8
N, AN, VN SUFFIX
CASE 626-05
ISSUE M

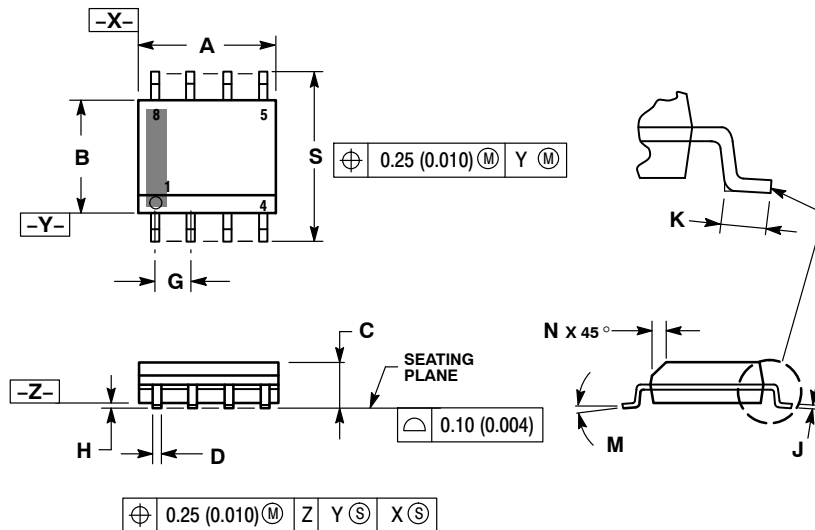


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSION E IS MEASURED WITH THE LEADS RESTRAINED PARALLEL AT WIDTH E2.
4. DIMENSION E1 DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	----	----	0.210	----	----	5.33
A1	0.015	----	----	0.38	----	----
b	0.014	0.018	0.022	0.35	0.46	0.56
C	0.008	0.010	0.014	0.20	0.25	0.36
D	0.355	0.365	0.400	9.02	9.27	10.02
D1	0.005	----	----	0.13	----	----
E	0.300	0.310	0.325	7.62	7.87	8.26
E1	0.240	0.250	0.280	6.10	6.35	7.11
E2	0.300 BSC			7.62 BSC		
E3	----	----	0.430	----	----	10.92
e	0.100 BSC			2.54 BSC		
L	0.115	0.130	0.150	2.92	3.30	3.81

PACKAGE DIMENSIONS

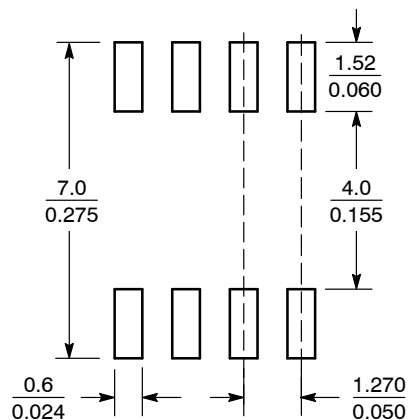
SOIC-8 NB
CASE 751-07
ISSUE AJ

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

SOLDERING FOOTPRINT*

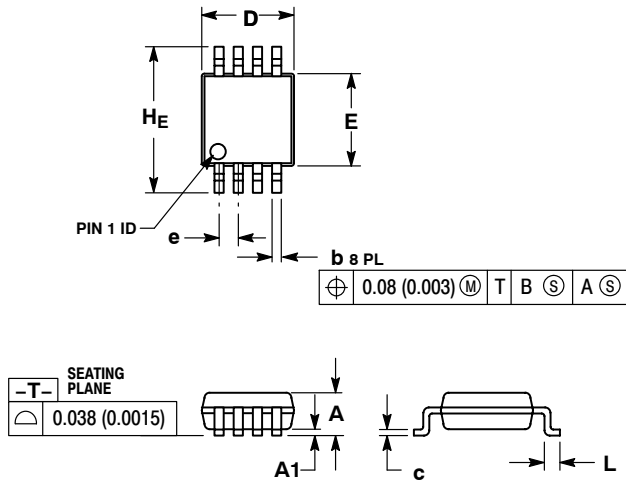
SCALE 6:1 $\left(\frac{\text{mm}}{\text{inches}}\right)$

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

LM258, LM358, LM358A, LM2904, LM2904A, LM2904V, NCV2904

PACKAGE DIMENSIONS

Micro8™ CASE 846A-02 ISSUE G

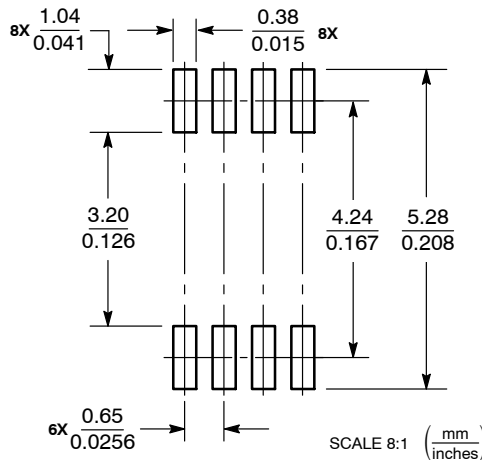


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. 846A-01 OBSOLETE, NEW STANDARD 846A-02.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	---	---	1.10	---	---	0.043
A1	0.05	0.08	0.15	0.002	0.003	0.006
b	0.25	0.33	0.40	0.010	0.013	0.016
c	0.13	0.18	0.23	0.005	0.007	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
E	2.90	3.00	3.10	0.114	0.118	0.122
e	0.65 BSC			0.026 BSC		
L	0.40	0.55	0.70	0.016	0.021	0.028
HE	4.75	4.90	5.05	0.187	0.193	0.199

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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